

Minutes from OpenPICs WP 3 meeting 09-10-2017

Present: Weiming (chairing), Rui, Rob, Huub, Meint, Xaveer

Time: 14:00-15:00

Discussion/action points

Nr.	Description	Responsible
1.	SP22 Cells Presentation of composite BB and RF line cells	
	SP19 Results Discussion on metal opening and minimum width dimensions	
2	SI library Rui comments that development of a separate library for semi-insulating substrate could be started.	
3	SP20 Metal has adhesion problem on some chips of SP20. This has not been transparently communicated	
4	Wafertesting Smart focuses first on Effect photonics chips and performs Gage R&R on multiprobe testing	
Action	PixApp pad layout Align with most up-to-date pixapp pad layout	Weiming

Next meeting is 23th October, 2017, 14:00